

# EMB-Q170A

## Thermal Image Analysis Report

Summary	<input type="checkbox"/> Pass <input type="checkbox"/> Fail <input checked="" type="checkbox"/> <b>Pass with Deviation</b> <b>Comment:</b> There are two temperature points marginal passed but they function are normal during the thermal test.			
<b>Test Result Summary</b>				
	Critical	Major	Minor	Enhancement
Defect Found	0	0	0	2
Defect Unsolved	0	0	0	2

<b>Issue date</b>	<b>QE Manager</b>	<b>Test Engineer</b>
<b>2016 / 09 / 05</b>	<b>KJ Wang</b>	<b>Jerry Chen</b>

## Sample Configuration & Quantity Under Test

- **Model name : EMB-Q170A**
- **M/B Name : EMB-Q170A Rev. 1.02**
- **CPU : Intel Core i7-6700 3.40 GHz**
- **BIOS : R0.D (E17AAM0D) (06/28/2016)**
- **Chipset: Intel Q170**
- **Memory : Transcend / DDR4 2133 SO 16GB \*2 / SEC K4A8G085WB**
- **2.5" SATA HDD: Seagate / ST9120823AS 120GB**
- **Test Software : Windows 8.1 / Run PassMark Burn In Test 8.1 Pro**
- **ATX Power Supply: CWT / DSA400P-C 400W**
- **CPU Cooler :**



# Thermal Image Analysis

**1. Test Date: 2016-08-22**

**2. Test Product: EMB-Q170A**

**3. Test Site: AAEON QE Dept.**

**4. Temperature Measurement:**

**4.1. 20 Channel Thermal Recorder:**

**4.1.1 OMRON Inc,**

**4.2.2 Model: ZR-RX45**

**Date of Calibration: 12/18/2015**

**Due date of Calibration: 12/17/2016**

**Serial Number: H30481978**

**4.2. IR Scanner: Infrared Camera**

**4.2.1 NEC Avio Infrared Technologies Co., Ltd.**

**4.2.2 Model: Thermo GEAR G100W2-D**

**Date of Calibration: 12/01/2015**

**Due date of Calibration: 11/30/2016**

**Serial Number: 1051444**

**5. Test Condition:**

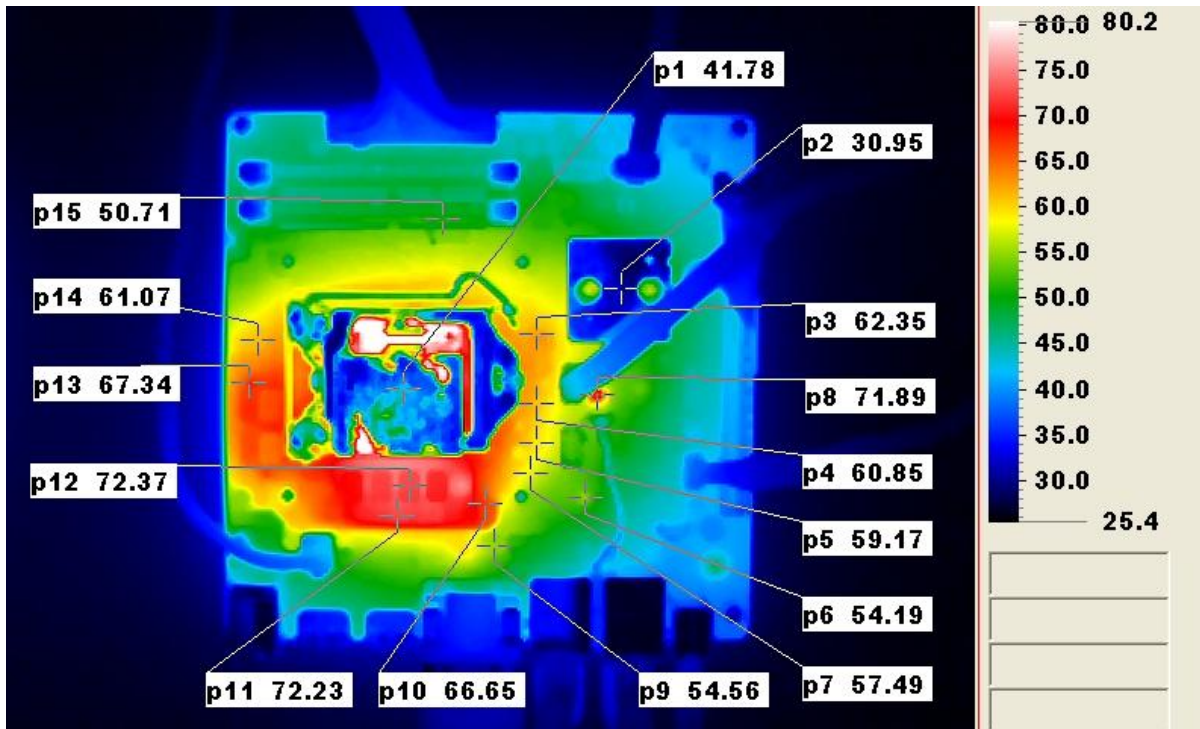
**Test by DA-100: 25.0°C with Cooler (Full speed)**

**6. Take Picture Time:**

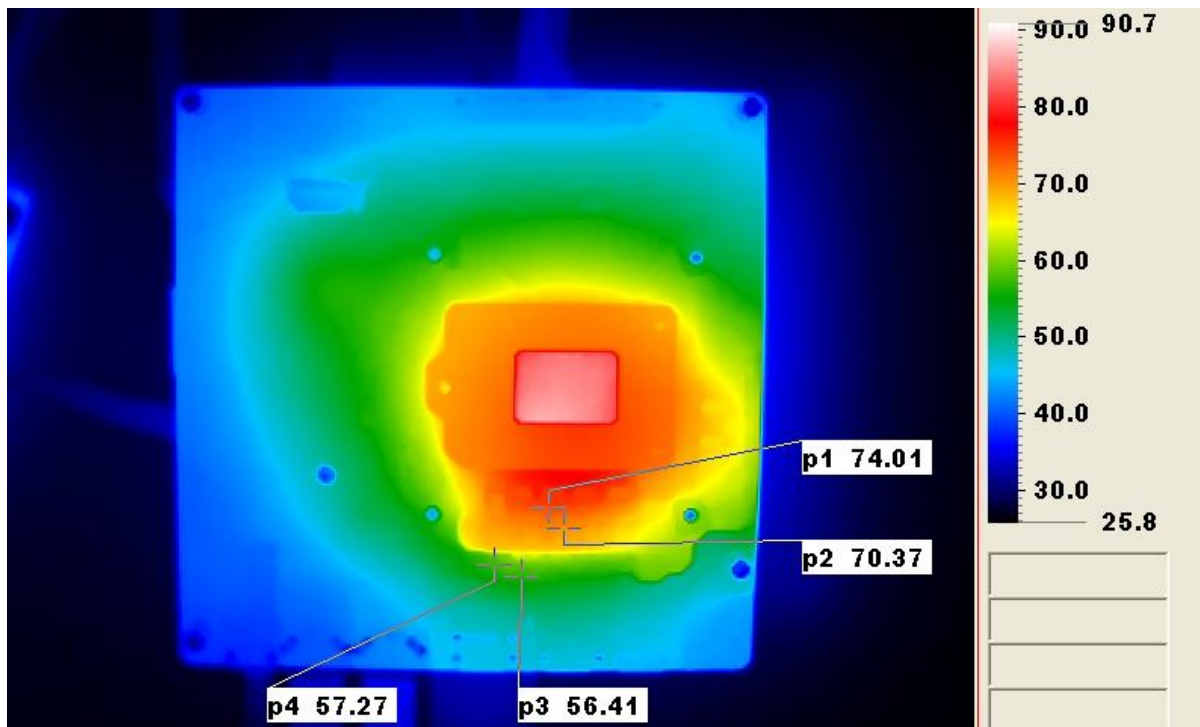
**After power on 2 hours**

### Temperature Profile Test:

#### Front Side:



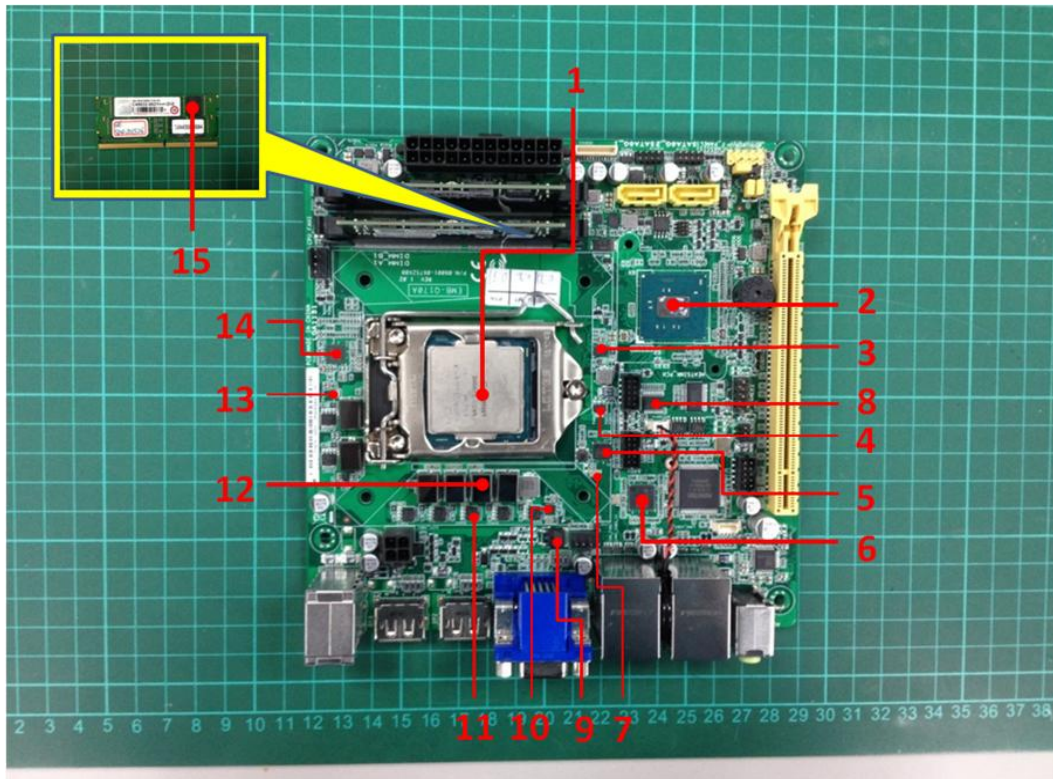
#### Back Side:



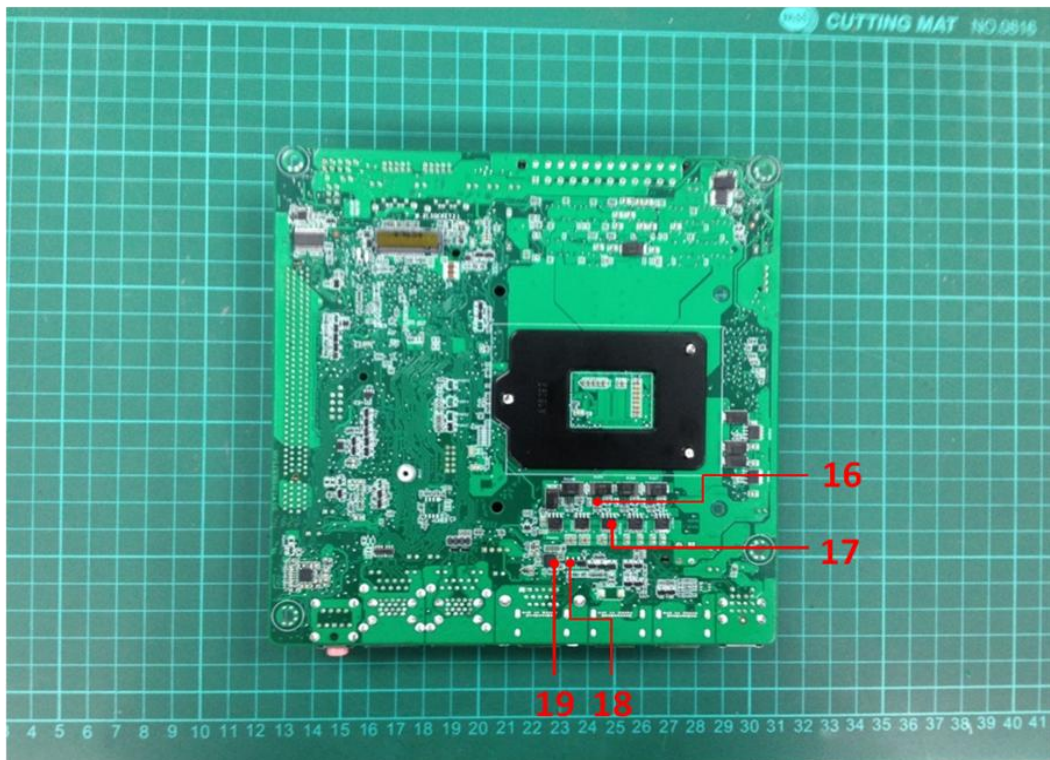
### Terminal Recorder:

Measuring Thermal Couple Position :

Front Side:



Back Side:



**Using OMRON Inc / ZR-RX45 test**

Point	Position	Describe	Tc (*1) (°C)	TAT(*2) TPT(*3)		Note
				25°C	60°C	
1	LGA1151	CPU Intel Core i7-6700 3.40 GHz	71	35	70	Note 6
2	SU1	PCH Q170	108	32.4	67.4	
3	PU92	PWM:HPA02240	125	32.6	67.6	
4	PQ868	NMOS:EMB45P03P	150	29.6	64.6	
5	L1U1	LAN WGI219LM	106	31.2	66.2	
6	L2U1	LAN I211AT	85	34.6	69.6	
7	L1X1	CRYSTAL 25MHZ	70	31.5	66.5	Note 6
8	OU8	75232 (MULTIPLE RS-232 DRIVERS)	125	43.9	78.9	
9	OQ4	PMOS:EMF90P02A	150	34.5	69.5	
10	PU101	RT8202M	100	36.1	71.1	
11	PQ882	NMOS: PH1530CL	150	46.3	81.3	
12	PL8	POWER INDUCTOR 0.215UH/48A	125	35.1	70.1	
13	PU103	MOSFET DRIVER: RT9624G	100	40	75	
14	PU96	PWM: RT3607CE	100	32.4	67.4	
15	RAM	Memory chipset / SEC K4A8G085WB	95	31.7	66.7	
16	PU99	MOSFET DRIVER: RT9624G	100	52.8	87.8	
17	PQ880	NMOS:PH6030DLB	150	49.6	84.6	
18	GU400	74LVC1G125	125	37.6	72.6	
19	GVU1	IT6516BFN/BX-0062	100	47.5	82.5	
20	N/A	Air Temperature	N/A	25	60	

**Note(\*):**

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "T<sub>AT</sub>" indicates the actual measured temperature under 25°C working environmental.
3. "T<sub>PT</sub>" indicates the predicted temperature under product specification.
4. **Judgment Criteria:**
  - **Fail** :  $T_m > T_c + 5^{\circ}\text{C}$ ; The measured value is over specification plus margin.
  - **Margin** :  $T_c + 5^{\circ}\text{C} > T_m > T_c - 10^{\circ}\text{C}$ ; The measured value is within specification with margin.  
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
  - **Pass** :  $T_m < T_c - 10^{\circ}\text{C}$ ; The measured value is with safety margin.
5. **RTC battery avoid to put on heat position.** Please do not exceed battery temperature specification.
6. Defect NO. : [W150913LABD01](#)